
FUTURE PLANS AND [REDACTED]

FUTURE PLANS

See “Business — Growth Strategies” for a detailed description of our future plans.

[REDACTED]

We estimate that we will receive [REDACTED] from the [REDACTED] of approximately HK\$[REDACTED], after deducting [REDACTED], fees and estimated expenses payable by us in connection with the [REDACTED] (based on the [REDACTED] of HK\$[REDACTED] per H Share), assuming the [REDACTED] is not exercised.

In line with our growth strategies, we intend to use the [REDACTED] for the following purposes, subject to adjustment in light of our evolving business needs and changing market conditions:

- (i) Approximately [REDACTED]%, or HK\$[REDACTED], will be used to enhance our R&D capabilities and expand our product portfolio. We believe such investment will strengthen our integrated technology platform and enable us to capture the growing opportunities in AI-enabled connectivity and computing across devices, edge and cloud. Specifically, we plan to use the [REDACTED] to fund R&D personnel costs, cover outsourced tape-out expenses, and procure R&D equipment, IP licenses, EDA tools and other R&D software. In particular, we plan to focus on the following key technology directions:
 - approximately [REDACTED]%, or HK\$[REDACTED], will be used for the R&D of next-generation cellular communication, AI computing and advanced-node chip design technologies for on-device AI applications. We plan to develop 5G-Advanced and future 6G communication capabilities spanning algorithm design, PHY layer and upper-layer protocol development, integration and system verification. We also plan to develop key AI computing and multimedia IP modules, such as NPU, ISP, DPU and VPU, for smartphones and other intelligent terminal devices, and advance our chip design capabilities at process nodes of 4nm and below. These technologies will underpin our new generation of smart device SoCs, enabling us to expand our product portfolio to meet growing demand for on-device AI;
 - approximately [REDACTED]%, or HK\$[REDACTED], will be used for the R&D of advanced SoC integration and low-power technologies. We plan to develop RF-baseband single-die architectures at process nodes of 6nm and below that integrate cellular and non-cellular connectivity technologies as well as MCU, NPU, Sensor Hub and ISP on a single chip, and to offer accompanying turnkey solutions including sample designs and software development kits to accelerate customer adoption. These technologies will underpin our new generation of ultra-low-power smart wearable SoCs and enable us to evolve our cost-effective wearable SoCs toward higher-performance solutions focused on premium user experiences, further strengthening our competitive edge in the wearable market;
 - approximately [REDACTED]%, or HK\$[REDACTED], will be used for the R&D of advanced non-cellular connectivity technologies. For example, we plan to develop foundational IP compliant with Wi-Fi 8 and other next-generation non-cellular connectivity standards, spanning algorithm design, PHY layer, MAC and upper-layer protocol development, integration and system verification, supporting both Station and AP modes as well as coexistence capabilities with Bluetooth, GNSS and cellular technologies. These technologies are designed to address the growing diversified connectivity requirements of smartphones, smart home devices, consumer electronics, industrial IoT and other connected devices, and to support our future expansion into router products; and

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- approximately [REDACTED]%, or HK\$[REDACTED], will be used for the R&D of advanced chip customization technologies. We plan to develop high-speed interfaces, memory controllers, SoC architectures and foundational analog IP for advanced process nodes and to establish a versatile R&D platform with a portfolio of reusable self-developed IP. These capabilities will support the delivery of edge-to-cloud AI and enhance the R&D efficiency and market competitiveness of our custom ASIC solutions.
- (ii) Approximately [REDACTED]%, or HK\$[REDACTED], will be used for strategic investments or acquisitions in furtherance of our long-term growth strategy. We may selectively pursue investment and acquisition opportunities that demonstrate synergies with or complement our operations, including upstream and downstream companies in the semiconductor value chain, aiming to strengthen our integrated technology platform and accelerate our expansion across devices, edge and cloud. We will evaluate potential opportunities based on their strategic fit, complementary technologies or products, commercialization prospects, integration feasibility and financial discipline, as well as the expertise and stability of their management and R&D teams. As of the Latest Practicable Date, we had not identified any specific investment or acquisition target and were not engaged in negotiations with respect to any such target.
- (iii) Approximately [REDACTED]%, or HK\$[REDACTED], will be used to expand our sales network and enhance our sales and marketing capabilities. We plan to deepen our partnerships with leading module manufacturers, device manufacturers, telecom operators, internet companies, AI companies and system providers to keep our products aligned with market needs and expand our customer base. We will recruit additional marketing, sales and field application engineering personnel to expand our business development team and enhance our customer service and technical support capabilities. We also plan to participate in industry exhibitions, expos and forums to engage with existing and potential customers.
- (iv) Approximately [REDACTED]%, or HK\$[REDACTED], will be used for working capital and other general corporate purposes.

The additional [REDACTED] that we would receive if the [REDACTED] were exercised in full would be HK\$[REDACTED] (based on the [REDACTED] of HK\$[REDACTED] per H Share), and we intend to apply such additional [REDACTED] to the above uses on a pro rata basis.

To the extent that the [REDACTED] from the [REDACTED] (including the [REDACTED] from the exercise of the [REDACTED]) are either more or less than expected, we will adjust the allocation of the [REDACTED] for the above purposes on a pro rata basis.

To the extent that the [REDACTED] from the [REDACTED] are not immediately used for the above purposes or if we are unable to effect any part of our future development plans as intended, we may hold such funds in short-term interest-bearing accounts at licensed commercial banks and/or other authorized financial institutions (as defined under the Securities and Futures Ordinance or applicable laws and regulations in other jurisdictions). In such event, we will comply with the appropriate disclosure requirements under the Listing Rules. We will issue an appropriate announcement if there is any material change to the above proposed use of [REDACTED].